



Attorney Docket No: 0553-0194

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Suzawa et al.

Serial No.: 09/615,449

Filed: July 13, 2000

For: Wiring And Manufacturing Method Thereof,  
Semiconductor Device Comprising Said  
Wiring, And Dry Etching Method

Examiner: H. Trinh

Art Unit: 2814

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on

April 30, 2004

Signature

Shannon Wallace

Date

April 30, 2004

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT E (AFTER FINAL)**

In response to the Final Rejection dated January 2, 2004, a one month extension of time being submitted herewith, please amend the above-identified application as follows